
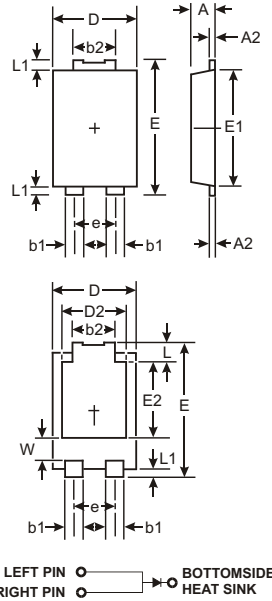


Features

- Guard Ring Die Construction for Transient Protection
- Low Forward Voltage Drop
- Very Low Leakage Current
- High Maximum Junction Temperature Capability
- Highly Stable Oxide Passivated Junction
- High Forward Surge Current Capability
- Lead Free Finish, RoHS Compliant (Note 1)**
- "Green" Molding Compound (No Br, Sb)**
- Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: PowerDI 5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish – Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 
- Polarity: See Diagram
- Ordering Information (See Page 3)
- Marking: Type Number (See Page 3)
- Weight: 0.096 grams (approximate)



Note: Pins Left & Right must be electrically connected at the printed circuit board.

PowerDI 5		
Dim	Min	Max
A	1.05	1.15
A2	0.33	0.43
b1	0.80	0.99
b2	1.70	1.88
D	3.90	4.05
D2	3.05 NOM	
E	6.40	6.60
e	1.84 NOM	
E1	5.30	5.45
E2	3.55 NOM	
L	0.75	0.95
L1	0.50	0.65
W	1.20	1.50
All Dimensions in mm		

Maximum Ratings @ T_A = 25 C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	150	V
RMS Reverse Voltage	V _{R(RMS)}	106	V
Average Rectified Output Current (See also figure 4)	I _O	4	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	I _{FSM}	180	A

Thermal Characteristics

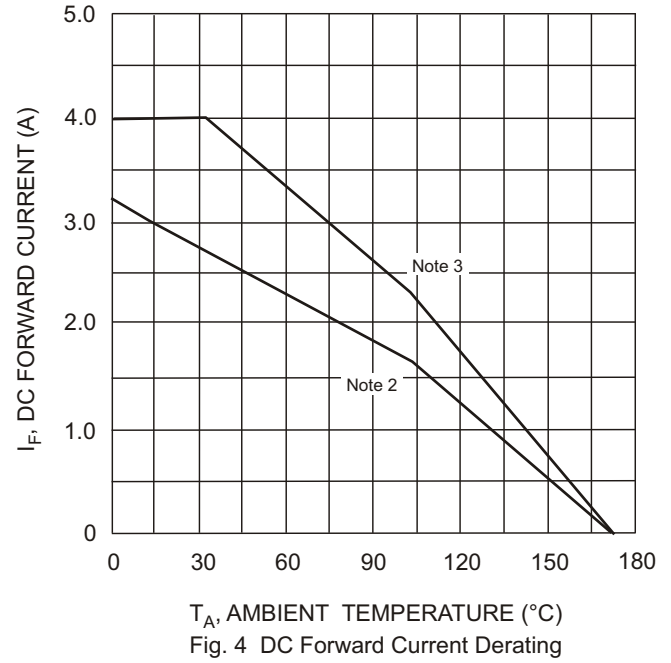
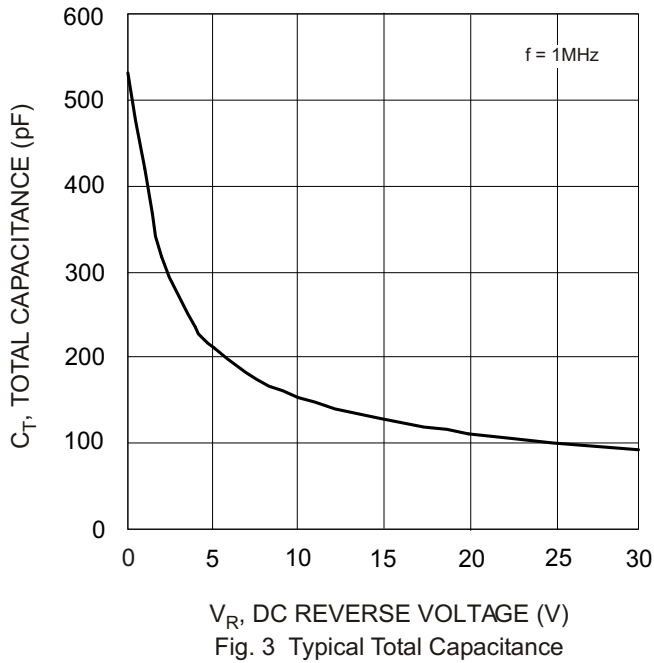
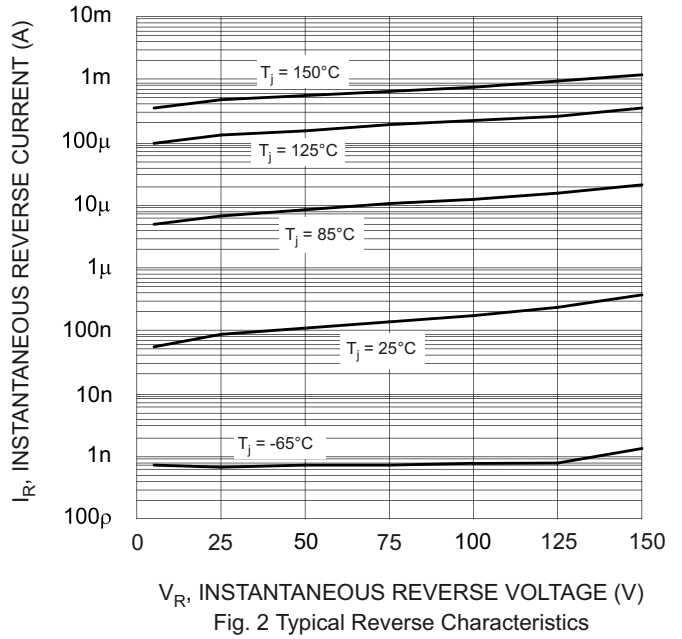
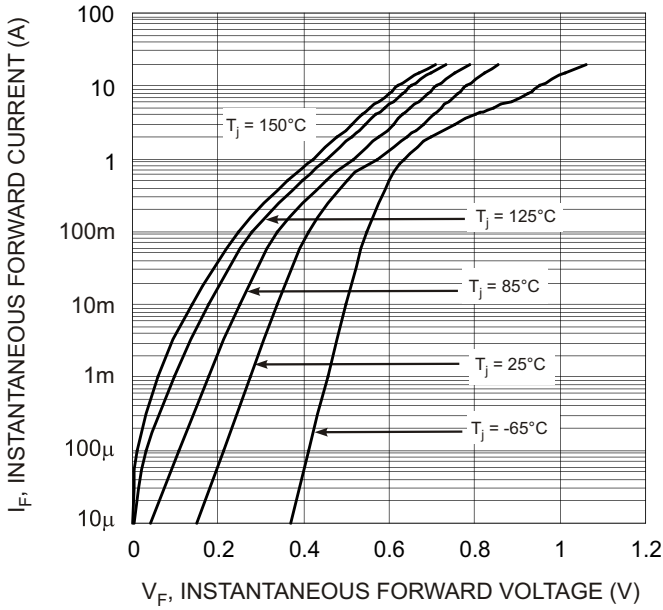
Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Soldering Point	R _{JS}		2.0	C/W
Thermal Resistance Junction to Ambient Air (Note 2) T _A = 25 C	R _{JA}	90		C/W
Thermal Resistance Junction to Ambient Air (Note 3) T _A = 25 C	R _{JA}	60		C/W
Thermal Resistance Junction to Ambient Air (Note 4) T _A = 25 C	R _{JA}	40		C/W
Operating Temperature Range	T _J	-65 to +175		C
Storage Temperature Range	T _{STG}	-65 to +175		°C

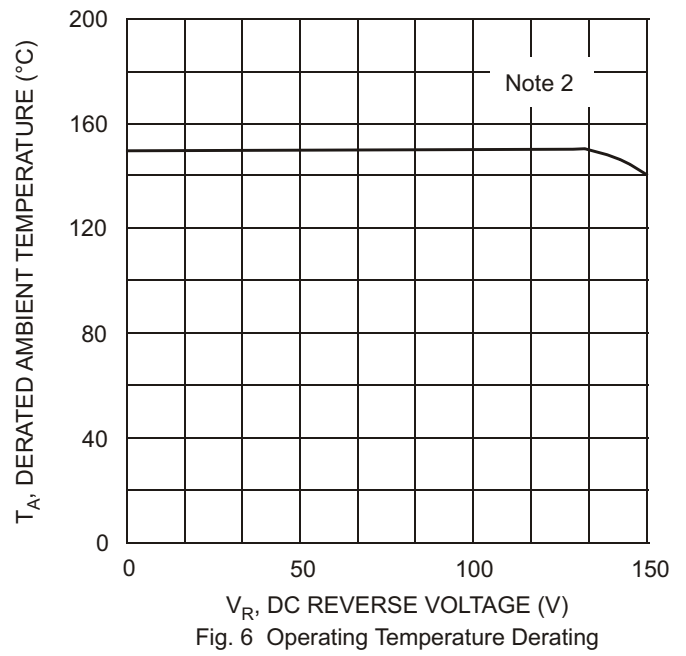
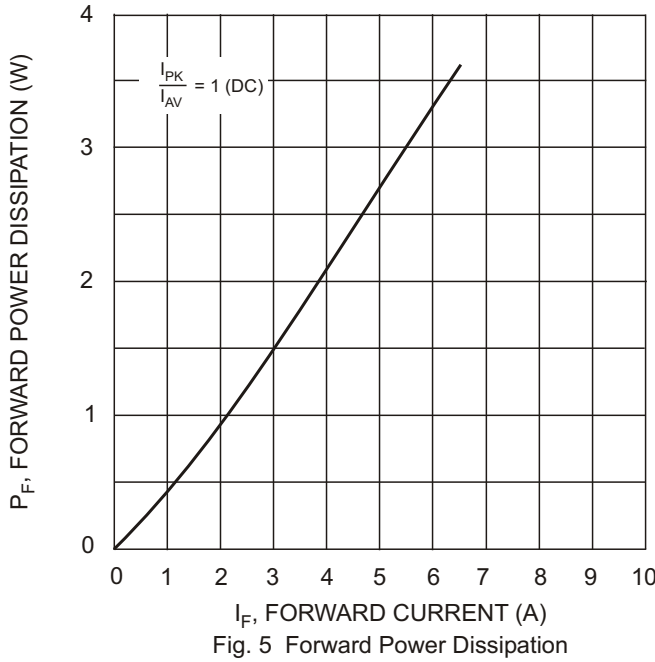
- Notes:
- RoHS revision 13.2.2003. High Temperature Solder Exemption Applied, see *EU Directive Annex Note 7*.
 - FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
 - Polymide PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
 - Polymide PCB, 2 oz. Copper. Cathode pad dimensions 9.4 mm x 7.2 mm. Anode pad dimensions 2.7 mm x 1.6 mm.

Electrical Characteristics @ $T_A = 25\text{ C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	$V_{(BR)R}$	150			V	$I_R = 10\text{ A}$
Forward Voltage	V_F		0.71 0.57 0.77 0.63	0.76 0.64 0.81 0.70	V	$I_F = 4\text{ A}, T_S = 25\text{ C}$ $I_F = 4\text{ A}, T_S = 125\text{ C}$ $I_F = 8\text{ A}, T_S = 25\text{ C}$ $I_F = 8\text{ A}, T_S = 125\text{ C}$
Reverse Leakage Current (Note 5)	I_R		0.3 0.4	10 4.5	A mA	$T_S = 25\text{ C}, V_R = 150\text{ V}$ $T_S = 125\text{ C}, V_R = 150\text{ V}$

Notes: 5. Short duration test pulse used to minimize self-heating effect.



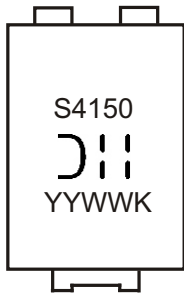


Ordering Information (Note 6)

Device	Packaging	Shipping
PDS4150-13	PowerDI 5	5000/Tape & Reel

Notes: 6. For Packaging Details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



S4150 = Product type marking code
)|| = Manufacturers' code marking
 YYWW = Date code marking
 YY = Last two digits of year ex: 05 for 2005
 WW = Week code 01 to 52
 K = Factory Designator

IMPORTANT NOTICE

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. Diodes Incorporated does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on our website, harmless against all damages.

LIFE SUPPORT

Diodes Incorporated products are not authorized for use as critical components in life support devices or systems without the expressed written approval of the President of Diodes Incorporated.